

Silicon P Channel MOS Type (U-MOSII)/Silicon Epitaxial Schottky Planar Diode

SSM5G01TU

DC-DC Converter for DSCs and Camcorders

- Co-packaged Pch MOSFET and Schottky Diode.
- Low R_{DS} (ON) and Low V_F

Maximum Ratings ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Rating	Unit
Drain-Source voltage	V_{DS}	-30	V
Gate-Source voltage	V_{GSS}	± 20	V
Drain current	DC	I_D	A
	Pulse	I_{DP} (Note 2)	
Channel temperature	P_D (Note 1)	0.5	W
	$t = 10\text{s}$	0.8	
Channel temperature	T_{ch}	150	$^\circ\text{C}$

Maximum Ratings ($T_a = 25^\circ\text{C}$) SCHOTTKY DIODE

Characteristics	Symbol	Rating	Unit
Maximum (peak) reverse voltage	V_{RM}	25	V
Reverse voltage	V_R	20	V
Average forward current	I_O	0.5	A
Peak one cycle surge forward current (non-repetitive)	I_{FSM}	2 (50 Hz)	A
Junction temperature	T_j	125	$^\circ\text{C}$

Maximum Ratings ($T_a = 25^\circ\text{C}$) MOSFET, DIODE COMMON

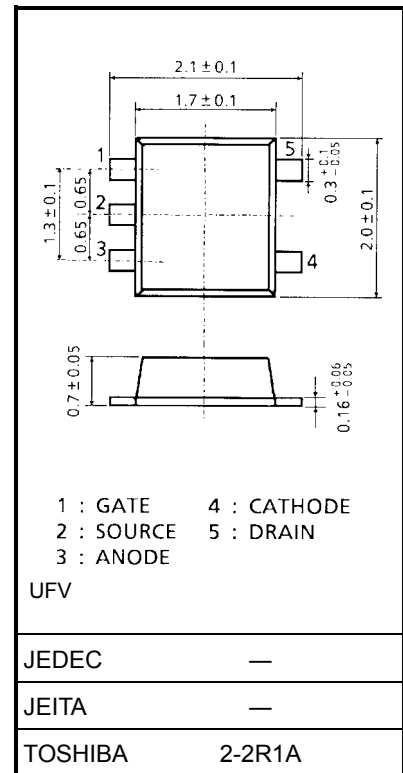
Characteristics	Symbol	Rating	Unit
Storage temperature	T_{stg}	-55~125	$^\circ\text{C}$
Operating temperature	T_{opr} (Note 3)	-40~100	$^\circ\text{C}$

Note 1: Mounted on FR4 board
(25.4 mm $\times$ 25.4 mm $\times$ 1.6 t, Cu pad: 645 mm²)

Note 2: The pulse width limited by max channel temperature.

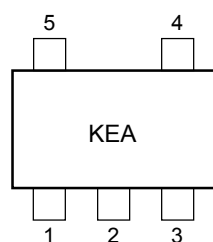
Note 3: Operating temperature limited by max channel temperature and max junction temperature.

Unit: mm

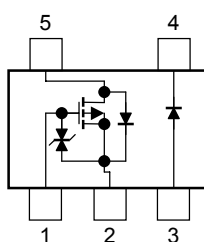


Weight: 7 mg (typ.)

Marking



Equivalent Circuit



Handling Precaution

When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

The Channel-to-Ambient thermal resistance $R_{th(ch-a)}$ and the drain power dissipation P_D vary according to the board material, board area, board thickness and pad area are also affected by the environment in which the product is used. When using this device, please take heat dissipation fully into account.

MOSFET

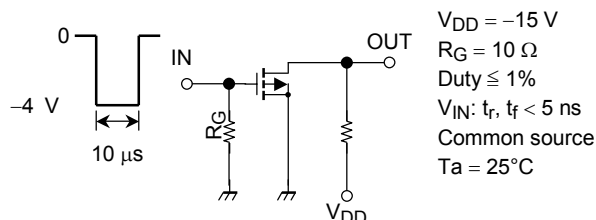
Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	I_{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$	—	—	± 1	μA
Drain-Source breakdown voltage	$V_{(BR)DSS}$	$I_D = -1 \text{ mA}, V_{GS} = 0$	-30	—	—	V
	$V_{(BR)DSX}$	$I_D = -1 \text{ mA}, V_{GS} = 20 \text{ V}$	-15	—	—	
Drain Cut-off current	I_{DSS}	$V_{DS} = -30 \text{ V}, V_{GS} = 0$	—	—	-1	μA
Gate threshold voltage	V_{th}	$V_{DS} = -5 \text{ V}, I_D = -0.1 \text{ mA}$	-0.8	—	-1.8	V
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = -5 \text{ V}, I_D = -0.5 \text{ A}$ (Note 4)	0.5	1.0	—	S
Drain-Source ON resistance	$R_{DS(ON)}$	$I_D = -0.5 \text{ A}, V_{GS} = -10 \text{ V}$ (Note 4)	—	0.3	0.4	Ω
		$I_D = -0.5 \text{ A}, V_{GS} = -4 \text{ V}$ (Note 4)	—	0.6	0.8	
Input capacitance	C_{iss}	$V_{DS} = -15 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	—	86	—	pF
Reverse transfer capacitance	C_{rss}	$V_{DS} = -15 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	—	14	—	pF
Output capacitance	C_{oss}	$V_{DS} = -15 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	—	25	—	pF
Switching time	Turn-on time	t_{on}	$V_{DD} = -15 \text{ V}, I_D = -0.5 \text{ A}$		14	ns
	Turn-off time	t_{off}			8.5	
		$V_{GS} = 0 \sim -4 \text{ V}, R_G = 10 \Omega$	—	—	—	

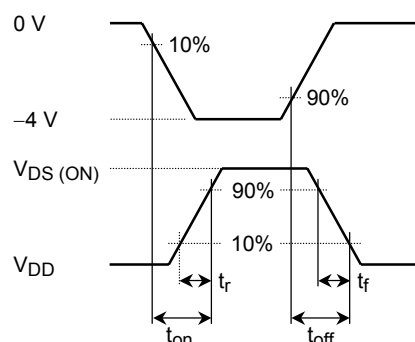
Note 4: Pulse measurement

Switching Time Test Circuit

(a) Test circuit



(b) V_{IN}



(c) V_{OUT}

Precaution

V_{th} can be expressed as voltage between gate and source when low operating current value is $I_D = -100 \mu\text{A}$ for this product. For normal switching operation, $V_{GS(on)}$ requires higher voltage than V_{th} and $V_{GS(off)}$ requires lower voltage than V_{th} .

(Relationship can be established as follows: $V_{GS(off)} < V_{th} < V_{GS(on)}$)

Please take this into consideration for using the device.

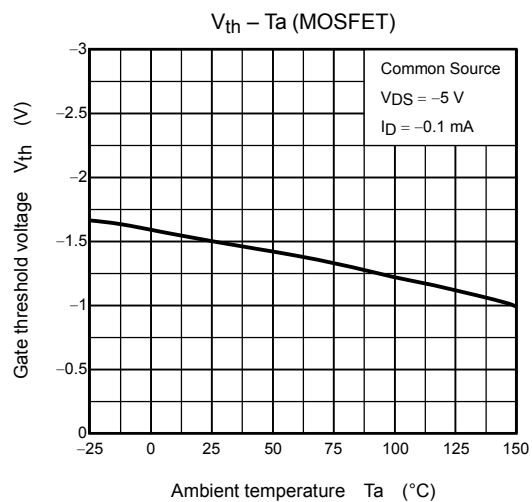
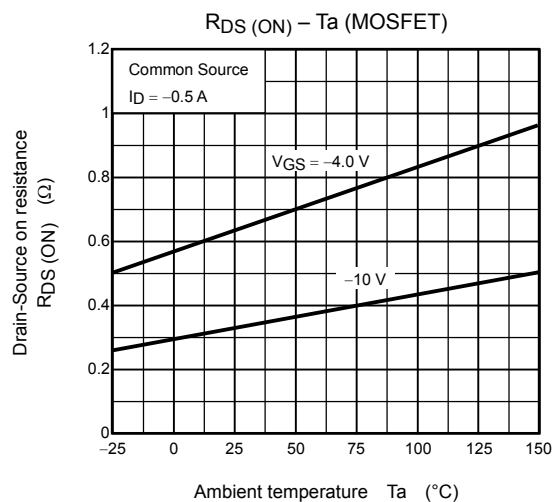
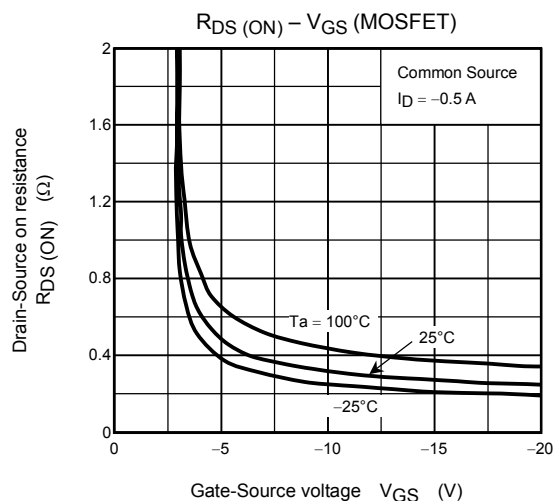
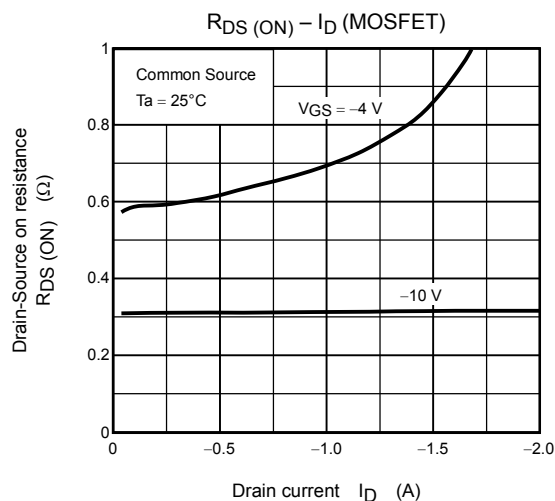
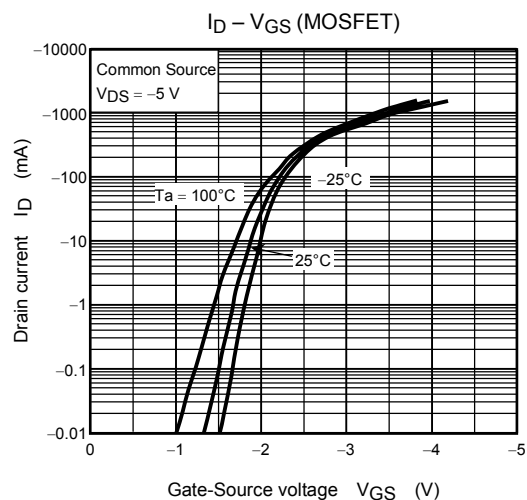
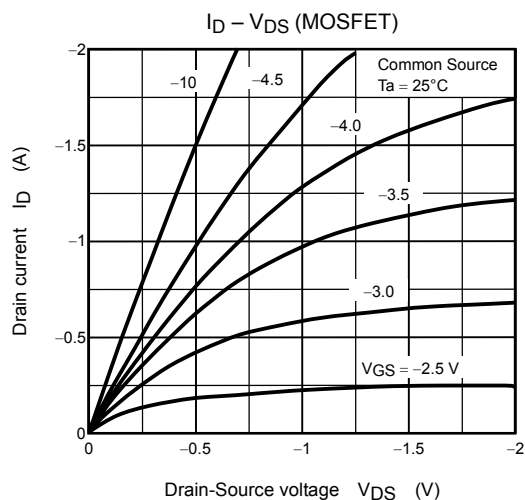
V_{GS} recommended voltage of -2.5 V or higher to turn on this product.

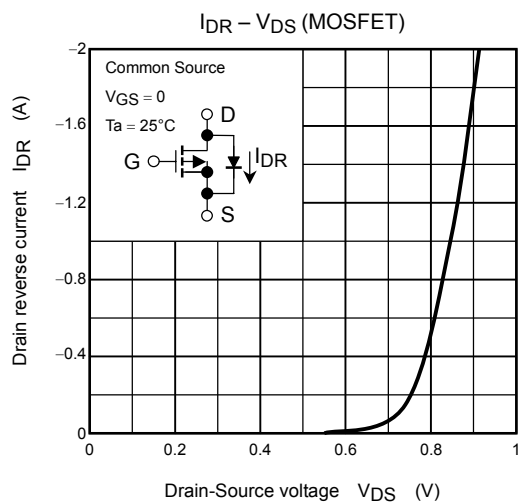
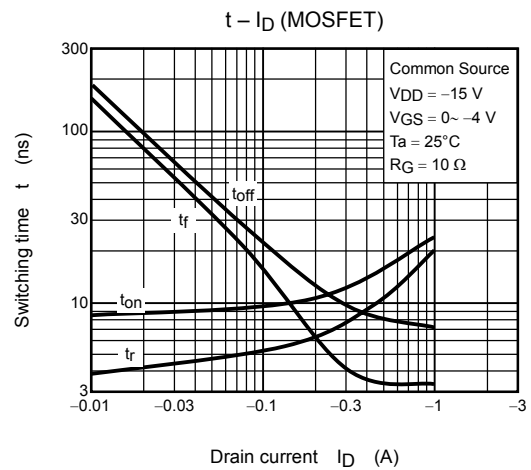
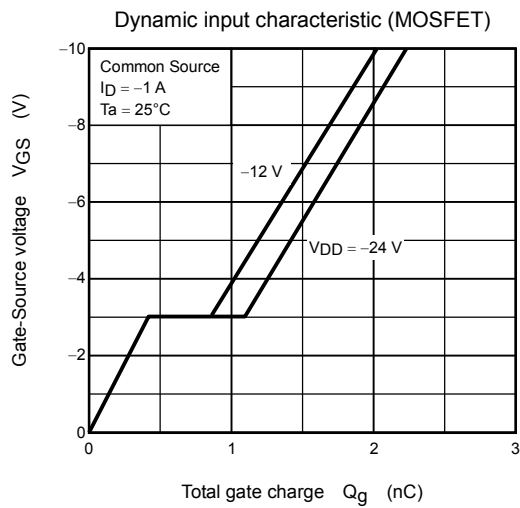
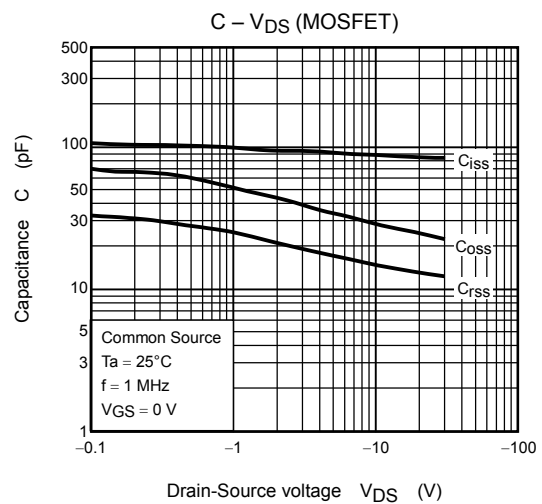
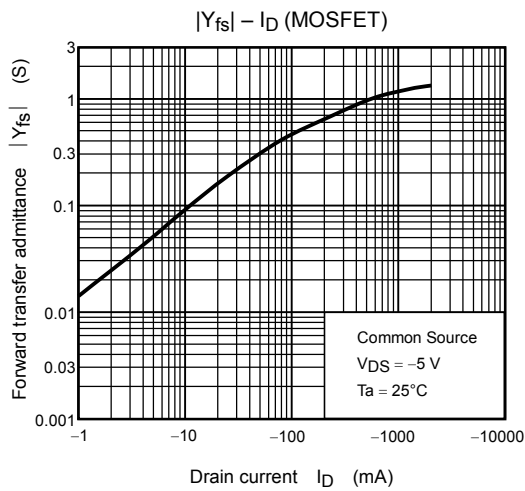
Schottky Diode**Electrical Characteristics (Ta = 25°C)**

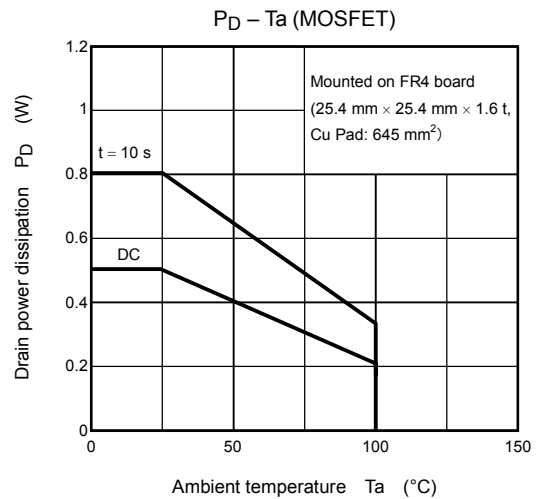
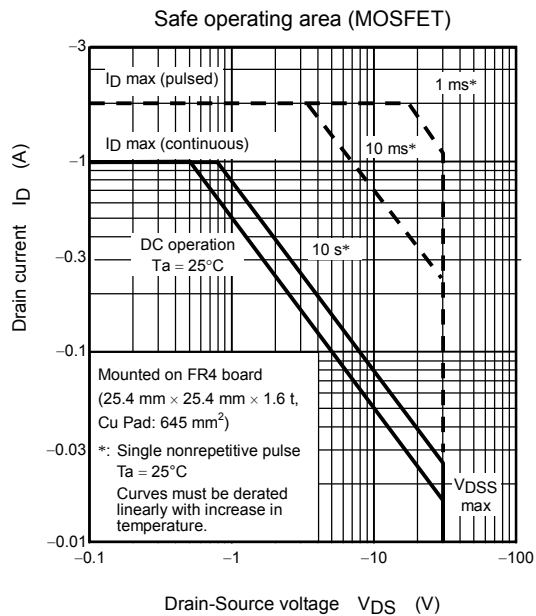
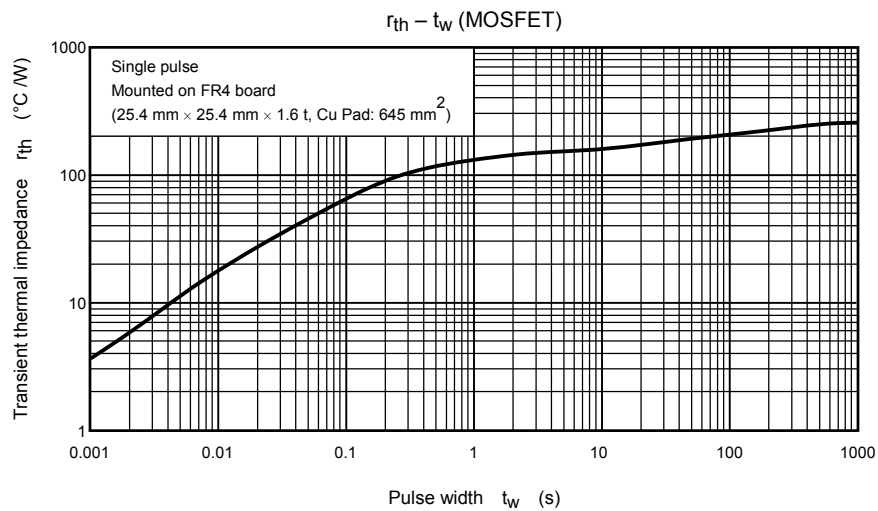
Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Forward voltage	V _{F (1)}	I _F = 0.3 A	—	0.38	0.45	V
	V _{F (2)}	I _F = 0.5 A	—	0.43	—	V
Reverse current	I _R	V _R = 20 V	—	—	50	μA
Total capacitance	C _T	V _R = 0 V, f = 1 MHz	—	46	—	pF

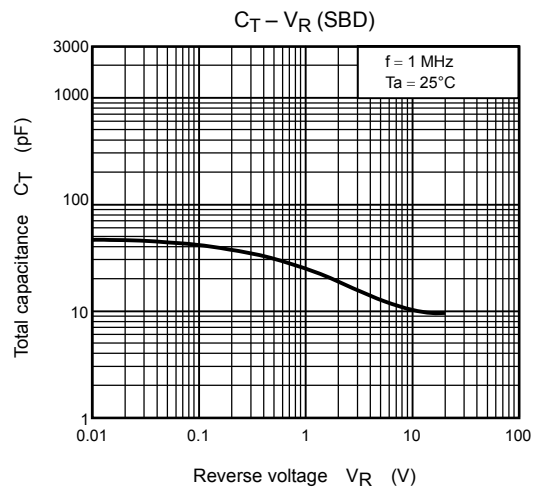
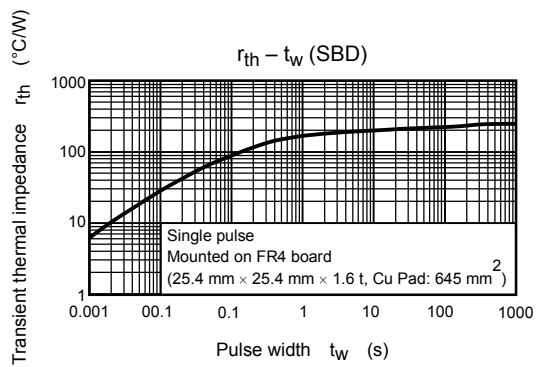
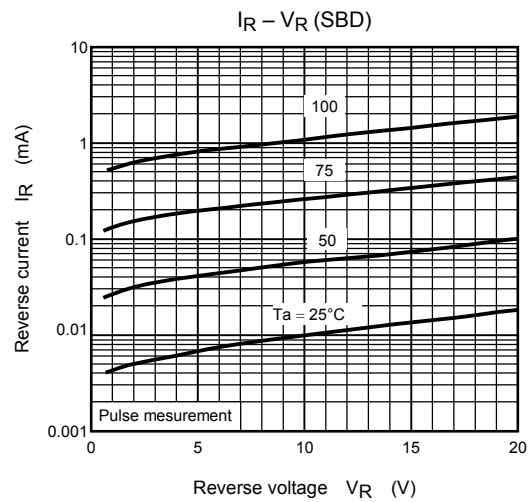
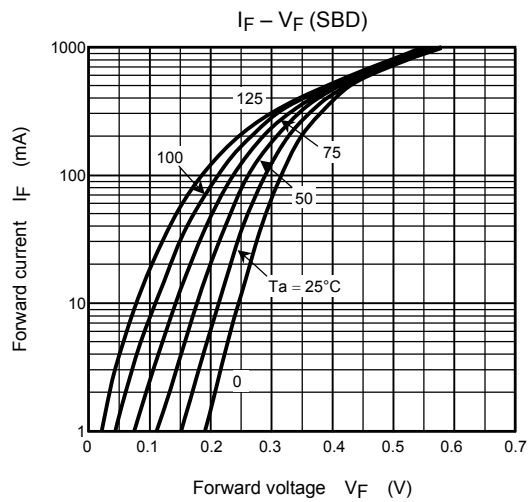
Precaution

The schottky barrier diode of this product are having large-reverse-current-leakage characteristic compare to the other switching diodes. This current leakage and not proper operating temperature or voltage may cause thermal runaway. Please take forward and reverse loss into consideration when you design.









RESTRICTIONS ON PRODUCT USE

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